

# NTLJS4114N

## Power MOSFET

30 V, 7.8 A,  $\mu$ Cool™ Single N-Channel, 2x2 mm WDFN Package

### Features

- WDFN Package Provides Exposed Drain Pad for Excellent Thermal Conduction
- 2x2 mm Footprint Same as SC-88
- Lowest  $R_{DS(on)}$  in 2x2 mm Package
- 1.8 V  $R_{DS(on)}$  Rating for Operation at Low Voltage Logic Level Gate Drive
- Low Profile (< 0.8 mm) for Easy Fit in Thin Environments
- This is a Pb-Free Device

### Applications

- DC-DC Conversion
- Boost Circuits for LED Backlights
- Optimized for Battery and Load Management Applications in Portable Equipment such as, Cell Phones, PDA's, Media Players, etc.
- Low Side Load Switch for Noisy Environment

### MAXIMUM RATINGS ( $T_J = 25^\circ\text{C}$ unless otherwise noted)

Parameter		Symbol	Value	Unit	
Drain-to-Source Voltage		$V_{DS}$	30	V	
Gate-to-Source Voltage		$V_{GS}$	$\pm 12$	V	
Continuous Drain Current (Note 1)	Steady State	$T_A = 25^\circ\text{C}$	$I_D$	6.0	A
		$T_A = 85^\circ\text{C}$		4.4	
	$t \leq 5$ s	$T_A = 25^\circ\text{C}$		7.8	
Power Dissipation (Note 1)	Steady State	$T_A = 25^\circ\text{C}$	$P_D$	1.92	W
		$t \leq 5$ s		3.3	
Continuous Drain Current (Note 2)	Steady State	$T_A = 25^\circ\text{C}$	$I_D$	3.6	A
		$T_A = 85^\circ\text{C}$		2.6	
Power Dissipation (Note 2)	Steady State	$T_A = 25^\circ\text{C}$	$P_D$	0.70	W
Pulsed Drain Current	$t_p = 10$ $\mu$ s	$I_{DM}$	28	A	
Operating Junction and Storage Temperature		$T_J, T_{STG}$	-55 to 150	$^\circ\text{C}$	
Source Current (Body Diode) (Note 2)		$I_S$	3.0	A	
Lead Temperature for Soldering Purposes (1/8" from case for 10 s)		$T_L$	260	$^\circ\text{C}$	

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

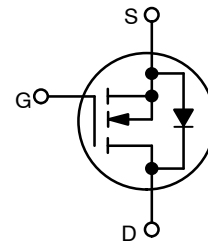
1. Surface Mounted on FR4 Board using 1 in sq pad size (Cu area = 1.127 in sq [2 oz] including traces).
2. Surface Mounted on FR4 Board using the minimum recommended pad size of 30 mm<sup>2</sup>, 2 oz Cu.



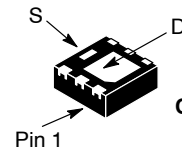
ON Semiconductor®

<http://onsemi.com>

$V_{(BR)DSS}$	$R_{DS(on)}$ MAX	$I_D$ MAX (Note 1)
30 V	35 m $\Omega$ @ 4.5 V	7.8 A
	45 m $\Omega$ @ 2.5 V	
	55 m $\Omega$ @ 1.8 V	

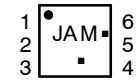


N-CHANNEL MOSFET



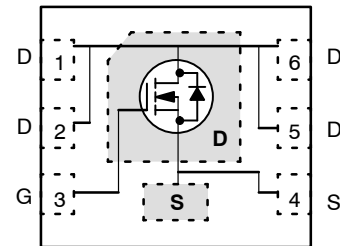
WDFN6  
CASE 506AP  
STYLE 1

### MARKING DIAGRAM



JA = Specific Device Code  
M = Date Code  
▪ = Pb-Free Package  
(Note: Microdot may be in either location)

### PIN CONNECTIONS



(Top View)

### ORDERING INFORMATION

Device	Package	Shipping†
NTLJS4114NT1G	WDFN6 (Pb-Free)	3000/Tape & Reel
NTLJS4114NTAG	WDFN6 (Pb-Free)	3000/Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

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## THERMAL RESISTANCE RATINGS

Parameter	Symbol	Max	Unit
Junction-to-Ambient – Steady State (Note 3)	$R_{\theta JA}$	65	°C/W
Junction-to-Ambient – $t \leq 5$ s (Note 3)	$R_{\theta JA}$	38	
Junction-to-Ambient – Steady State Min Pad (Note 4)	$R_{\theta JA}$	180	

3. Surface Mounted on FR4 Board using 1 in sq pad size (Cu area = 1.127 in sq [2 oz] including traces).  
 4. Surface Mounted on FR4 Board using the minimum recommended pad size (30 mm<sup>2</sup>, 2 oz Cu).

## MOSFET ELECTRICAL CHARACTERISTICS ( $T_J = 25^\circ\text{C}$ unless otherwise noted)

Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
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### OFF CHARACTERISTICS

Drain-to-Source Breakdown Voltage	$V_{(BR)DSS}$	$V_{GS} = 0$ V, $I_D = 250$ $\mu$ A	30			V
Drain-to-Source Breakdown Voltage Temperature Coefficient	$V_{(BR)DSS}/T_J$	$I_D = 250$ $\mu$ A, Ref to $25^\circ\text{C}$		20		mV/°C
Zero Gate Voltage Drain Current	$I_{DSS}$	$V_{DS} = 24$ V, $V_{GS} = 0$ V	$T_J = 25^\circ\text{C}$		1.0	$\mu$ A
			$T_J = 85^\circ\text{C}$		10	
Gate-to-Source Leakage Current	$I_{GSS}$	$V_{DS} = 0$ V, $V_{GS} = \pm 12$ V			$\pm 100$	nA

### ON CHARACTERISTICS (Note 5)

Gate Threshold Voltage	$V_{GS(TH)}$	$V_{GS} = V_{DS}$ , $I_D = 250$ $\mu$ A	0.4	0.55	1.0	V
Negative Gate Threshold Temperature Coefficient	$V_{GS(TH)}/T_J$			3.18		mV/°C
Drain-to-Source On-Resistance	$R_{DS(on)}$	$V_{GS} = 4.5$ V, $I_D = 2.0$ A		20.3	35	m $\Omega$
		$V_{GS} = 2.5$ V, $I_D = 2.0$ A		25.8	45	
		$V_{GS} = 1.8$ V, $I_D = 1.8$ A		35.2	55	
Forward Transconductance	$g_{FS}$	$V_{DS} = 16$ V, $I_D = 2.0$ A		8		S

### CHARGES, CAPACITANCES AND GATE RESISTANCE

Input Capacitance	$C_{ISS}$	$V_{GS} = 0$ V, $f = 1.0$ MHz, $V_{DS} = 15$ V		650		pF
Output Capacitance	$C_{OSS}$			115.5		
Reverse Transfer Capacitance	$C_{RSS}$			70		
Total Gate Charge	$Q_{G(TOT)}$	$V_{GS} = 4.5$ V, $V_{DS} = 15$ V, $I_D = 2.0$ A		8.5	13	nC
Threshold Gate Charge	$Q_{G(TH)}$			0.6		
Gate-to-Source Charge	$Q_{GS}$			0.9		
Gate-to-Drain Charge	$Q_{GD}$			2.1		
Gate Resistance	$R_G$			3.0		

### SWITCHING CHARACTERISTICS (Note 6)

Turn-On Delay Time	$t_{d(ON)}$	$V_{GS} = 4.5$ V, $V_{DD} = 15$ V, $I_D = 2.0$ A, $R_G = 3.0$ $\Omega$		5		ns
Rise Time	$t_r$			9		
Turn-Off Delay Time	$t_{d(OFF)}$			20		
Fall Time	$t_f$			4		

### DRAIN-SOURCE DIODE CHARACTERISTICS

Forward Recovery Voltage	$V_{SD}$	$V_{GS} = 0$ V, $I_S = 2.0$ A	$T_J = 25^\circ\text{C}$		0.71	1.2	V
			$T_J = 85^\circ\text{C}$		0.58		
Reverse Recovery Time	$t_{RR}$	$V_{GS} = 0$ V, $d_{ISD}/d_t = 100$ A/ $\mu$ s, $I_S = 1.0$ A			14	35	ns
Charge Time	$t_a$				8.0		
Discharge Time	$t_b$				6.0		
Reverse Recovery Time	$Q_{RR}$				5.0		

5. Pulse Test: Pulse Width  $\leq 300$   $\mu$ s, Duty Cycle  $\leq 2\%$ .  
 6. Switching characteristics are independent of operating junction temperatures.

TYPICAL PERFORMANCE CURVES ( $T_J = 25^\circ\text{C}$  unless otherwise noted)

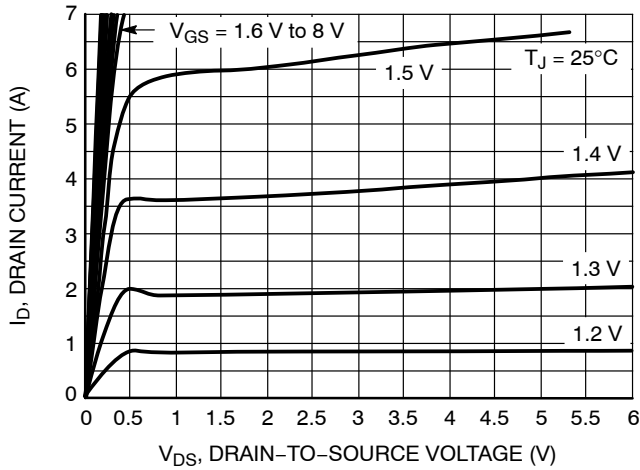


Figure 1. On-Region Characteristics

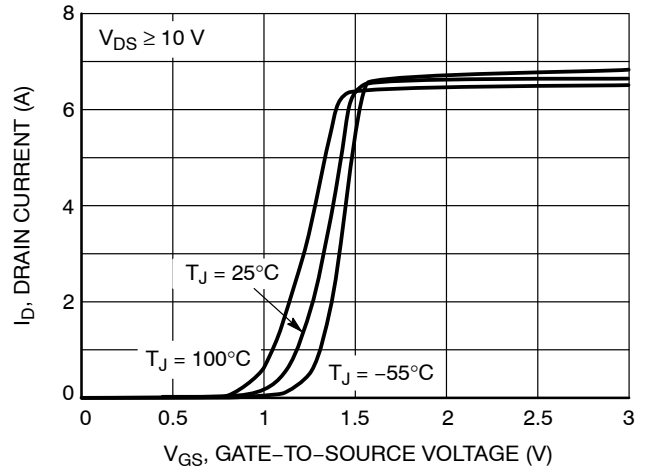


Figure 2. Transfer Characteristics

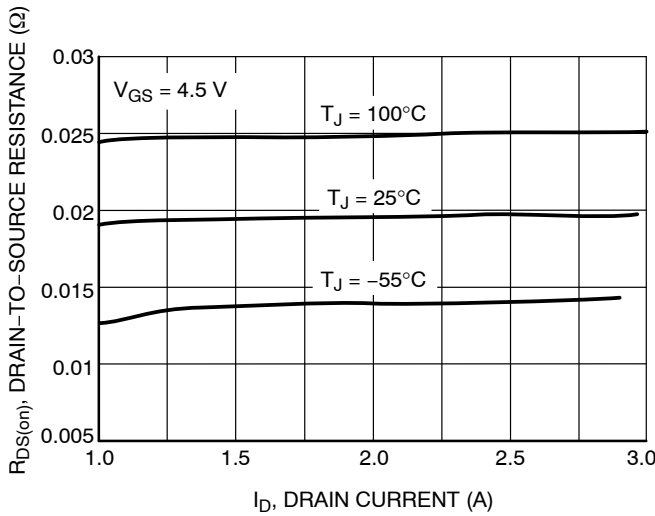


Figure 3. On-Resistance versus Drain Current

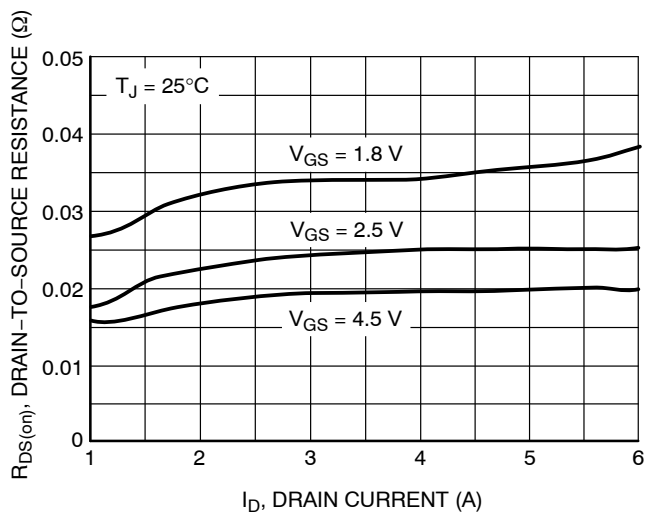


Figure 4. On-Resistance versus Drain Current and Gate Voltage

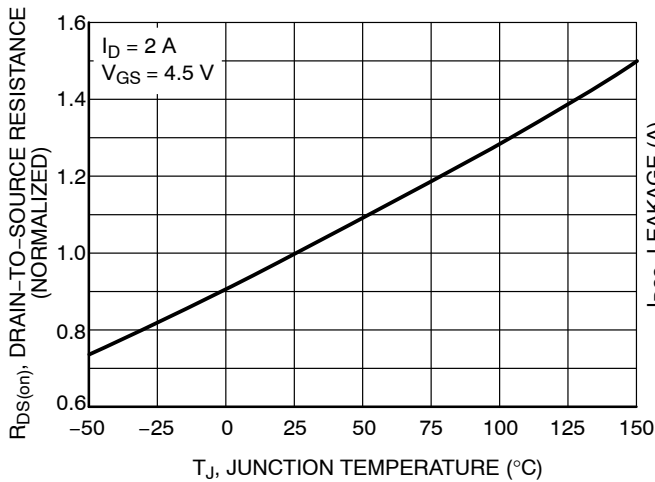


Figure 5. On-Resistance Variation with Temperature

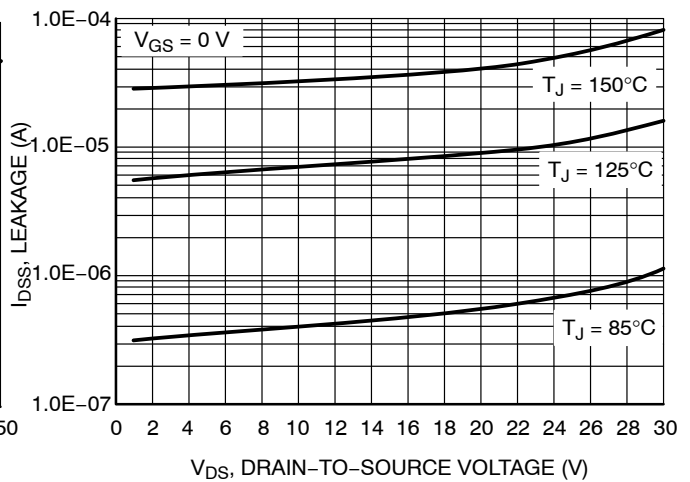


Figure 6. Drain-to-Source Leakage Current versus Voltage

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## TYPICAL PERFORMANCE CURVES ( $T_J = 25^\circ\text{C}$ unless otherwise noted)

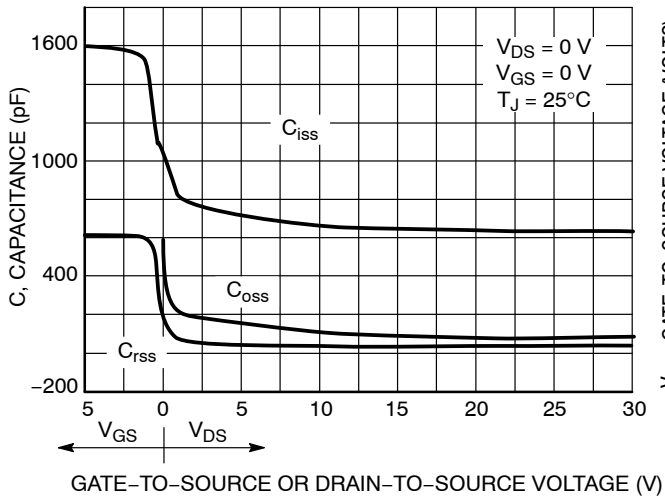


Figure 7. Capacitance Variation

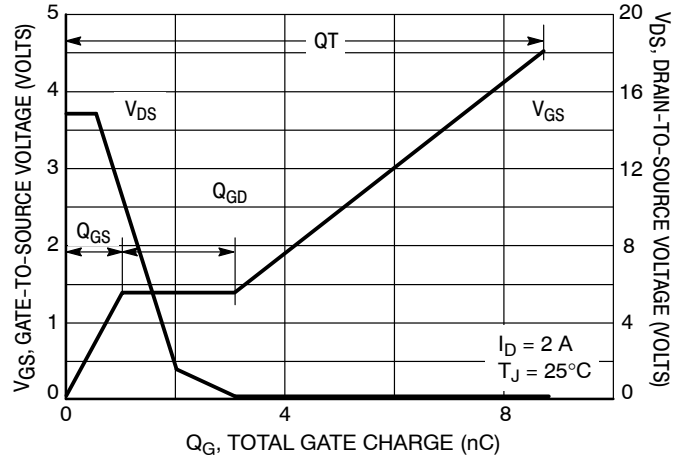


Figure 8. Gate-To-Source and Drain-To-Source Voltage versus Total Charge

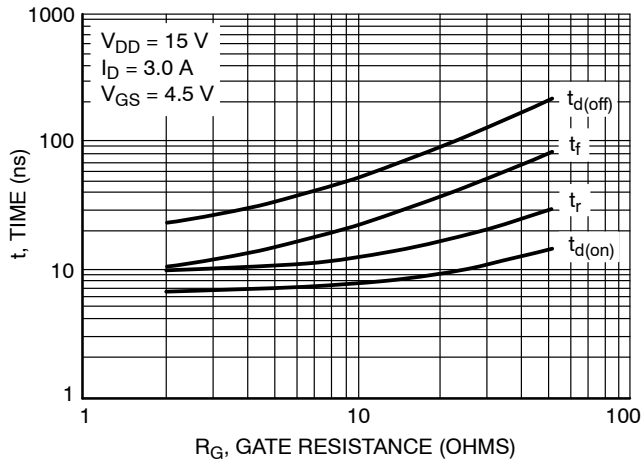


Figure 9. Resistive Switching Time Variation versus Gate Resistance

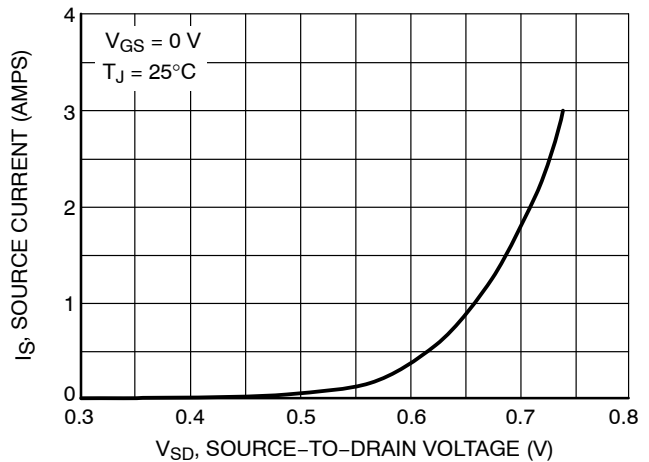


Figure 10. Diode Forward Voltage versus Current

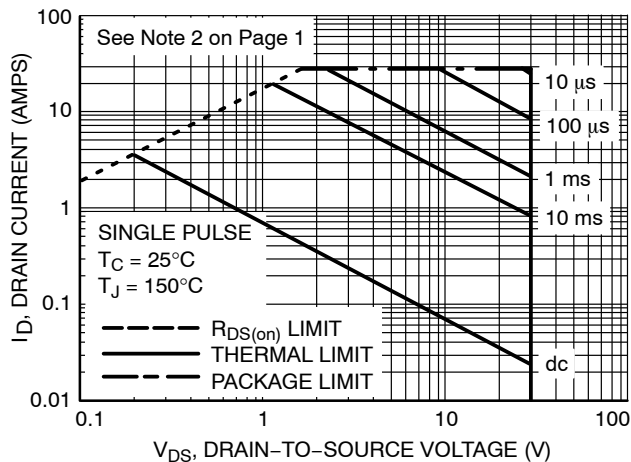


Figure 11. Maximum Rated Forward Biased Safe Operating Area

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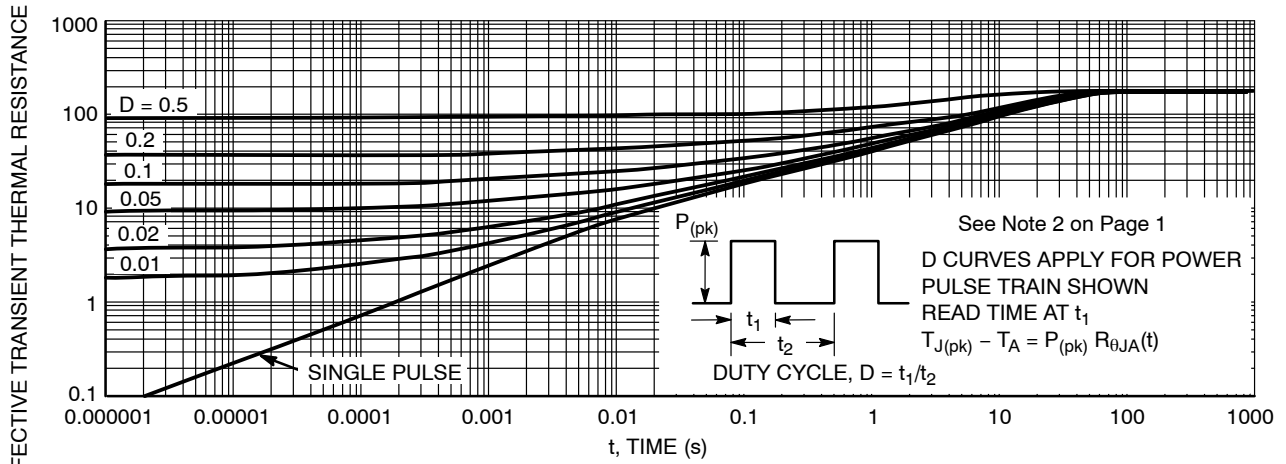


Figure 12. Thermal Response





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